

**WWW.ICMMM  
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We cordially invite you to participate in this event to be held in Washington, USA, on September 25-27, 2020, co-sponsored by Capitol Technology University, USA, with its workshop [TMAE 2020](#).

## HOW TO CONTACT US

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## KEY DATES

Submission Deadline:  
**May 15, 2020**  
Notification Date:  
**June 05, 2020**  
Registration Date:  
**June 20, 2020,**

## PUBLICATION & INDEXING

Accepted and presented papers in ICMMM 2020 will be included into Conference proceedings, published by **IOP Conference Series: Materials Science and Engineering**, and submitted for Ei Compendex and Scopus, Thomson Reuters (WoS), Inspec index, et al.

ICMMM2017 and 2018 accepted papers have been indexed by Ei Compendex and Scopus already.

ICMMM 2019 has been online in IOP Conference Series: Materials Science and Engineering .

# ICMMM 2020

## 7th International Conference on Mechanical, Materials and Manufacturing



## CALL FOR PAPERS

### MATERIAL SCIENCE AND ENGINEERING:

- Composite Materials
- Materials Physics and Chemistry
- New Energy Materials
- Surface Engineering/Coatings
- Microwave Processing of Materials
- Laser Processing Technology
- Material Design of Computer Aided

### MECHANICAL AND MANUFACTURING ENGINEERING

- Energy Conversion System
- Industrial Tribology
- Optimization of Systems
- Mechanical and Materials Engineering
- Aerospace Systems and Technology
- Instrumentation and Control
- Tribology and Reverse Engineering

## SUBMISSION & REGISTRATION

- **Electronic Submission System**
- <http://confsys.iconf.org/submission/icmmm2020>

- **Paper Template Download** ↓
- **Listener Registration Form** ↓

### • Submission Type

Full Paper (Publication & Oral Presentation) / Abstract (Oral Presentation only)

Please prepare your paper carefully according to the paper template. The full paper should be at least 5 pages.

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